

MMC2001HCAB33B (Active)

PB-FREE MMC2001

[Data Sheet](#)[Product Summary](#)[Software & Tools](#)[Documentation](#)

Package :

[LQFP144](#)

LQFP144, plastic, low profile
quad flat package; 144 terminals;
0.5 mm pitch; 20 mm x 20 mm x
1.4 mm body

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Buy Options

MMC2001HCAB33B Active TRAY-Tray, Bakeable, Multiple in Drypack

[Distributor](#)

935315771557

Min. Package Quantity: 60

Lead Time: 10 weeks

Environmental Information

Material Declaration	PbFree	EU RoHS	Halogen Free	RHF Indicator	2nd Level Interconnect	REACH SVHC	Weight (mg)
MMC2001HCAB33B (935315771557)	Yes	Yes Certificate Of Analysis (CoA)	Yes	D	e3	REACH SVHC	1319.1

Quality Information

Material Declaration	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)	Peak Package Body Temperature (PPT) (C°)	Maximum Time at Peak Temperatures (s)
		Lead Free Soldering	Lead Free Soldering	Lead Free Soldering
MMC2001HCAB33B (935315771557)	No	3	260	40

Shipping Information

Part Number	Harmonized Tarrif (US) Disclaimer	Export Control Classification Number (US)
MMC2001HCAB33B (935315771557)	854231	3A991A2

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